## FEATURES

－Low ON－State Resistance（ $\mathrm{r}_{\mathrm{on}}$ ）
－ $0.9 \Omega$ Max（3－V Supply）
－ $1.5 \Omega$ Max（1．8－V Supply）
－$r_{\text {on }}$ Flatness： $0.4 \Omega$ Max（3－V）
－$r_{\text {on }}$ Matching
－ $0.05 \Omega$ Max（3－V Supply）
－ $0.25 \Omega$ Max（1．8－V Supply）
－ $1.6-\mathrm{V}$ to $3.6-\mathrm{V}$ Single－Supply Operation
－ $1.8-\mathrm{V}$ CMOS Logic Compatible（3－V Supply）
－High Current－Handling Capacity（ 100 mA Continuous）
－Fast Switching： $\mathrm{t}_{\mathrm{ON}}=14 \mathrm{~ns}, \mathrm{t}_{\text {OFF }}=9 \mathrm{~ns}$
－ESD Protection Exceeds JESD－22
－4000－V Human Body Model（A114－A）
－300－V Machine Model（A115－A）
－1000－V Charged Device Model（C101）

## APPLICATIONS

－Power Routing
－Battery Powered Systems
－Audio and Video Signal Routing
－Low－Voltage Data－Acquisition Systems
－Communications Circuits
－PCMCIA Cards
－Cellular Phones
－Modems
－Hard Drives

## DESCRIPTION／ORDERING INFORMATION

The TS3A4751 is a low ON－state resistance（ $r_{\text {on }}$ ），low－voltage，quad，single－pole／single－throw（SPST）analog switch that operates from a single $1.6-\mathrm{V}$ to $3.6-\mathrm{V}$ supply．This device has fast switching speeds，handles rail－to－rail analog signals，and consumes very low quiescent power．

The digital input is $1.8-\mathrm{V}$ CMOS compatible when using a single $3-\mathrm{V}$ supply．
The TS3A4751 has four normally open（NO）switches．The TS3A4751 is available in a 14－pin thin shrink small－outline package（TSSOP）．

ORDERING INFORMATION

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE ${ }^{(1)}$ |  | ORDERABLE PART NUMBER | TOP－SIDE MARKING |
| ---: | :--- | :--- | :--- | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | TSSOP - PWR | Reel of 2000 | TS3A4751PWR | YC751 |

（1）Package drawings，standard packing quantities，thermal data，symbolization，and PCB design guidelines are available at www．ti．com／sc／package．

## FUNCTION TABLE

| IN | NO TO COM， <br> COM TO NO |
| :---: | :---: |
| L | OFF |
| H | ON |

[^0]TS3A4751
0.9- $\Omega$ LOW-VOLTAGE SINGLE-SUPPLY QUAD SPST ANALOG SWITCH

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## Absolute Maximum Ratings ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{+}$ | Supply voltage range referenced to GND ${ }^{(2)}$ |  | -0.3 | 4 | V |
| $\mathrm{V}_{\mathrm{NO}}$ <br> $\mathrm{V}_{\mathrm{COM}}$ <br> $\mathrm{V}_{\text {IN }}$ | Analog and digital voltage range |  | -0.3 | $\mathrm{V}_{+}+0.3$ | V |
| $\begin{array}{\|l\|} \hline \mathrm{I}_{\mathrm{NO}} \\ \mathrm{I}_{\mathrm{COM}} \\ \hline \end{array}$ | On-state switch current | $\mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$ | -100 | 100 | mA |
| $\begin{aligned} & I_{+} \\ & I_{\mathrm{GND}} \end{aligned}$ | Continuous current through $\mathrm{V}_{+}$or GND |  |  | $\pm 100$ | mA |
|  | Peak current pulsed at $1 \mathrm{~ms}, 10 \%$ duty cycle | COM, $\mathrm{V}_{1 / \mathrm{O}}$ |  | $\pm 200$ | mA |
| $\theta_{\text {JA }}$ | Package thermal impedance ${ }^{(3)}$ |  |  | 88 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{T}_{\mathrm{A}}$ | Operating temperature range |  | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J}}$ | Junction temperature |  |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Signals on COM or NO exceeding $\mathrm{V}_{+}$or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.
(3) The package thermal impedance is measured in accordance with JESD 51-7.

## Electrical Characteristics for 3-V Supply ${ }^{(1)(2)}$

$\mathrm{V}_{+}=2.7 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}, \mathrm{V}_{\text {IH }}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.5 \mathrm{~V}$ (unless otherwise noted).

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\mathrm{A}}$ | MIN | TYP ${ }^{(3)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {NO }}$ |  |  |  | 0 |  | $\mathrm{V}_{+}$ | V |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{+}=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{NO}}=1.5 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.7 | 0.9 | $\Omega$ |
|  |  |  |  | Full |  |  | 1.1 |  |
| ON-state resistance match between channels ${ }^{(4)}$ | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{+}=2.7 \mathrm{~V}, \mathrm{I}_{\text {com }}=-100 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{NO}}=1.5 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.03 | 0.05 | $\Omega$ |
|  |  |  |  | Full |  |  | 0.15 |  |
| ON-state resistance flatness ${ }^{(5)}$ | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & \mathrm{V}_{+}=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{NO}}=1 \mathrm{~V}, 1.5 \mathrm{~V}, 2 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.23 | 0.4 | $\Omega$ |
|  |  |  |  | Full |  |  | 0.5 |  |
| NO <br> OFF leakage current ${ }^{6)}$ | $\mathrm{I}_{\text {NO(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{+}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, 3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=3 \mathrm{~V}, 0.3 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -2 | 1 | 2 | nA |
|  |  |  |  | Full | -18 |  | 18 |  |
| COM <br> OFF leakage current ${ }^{(6)}$ | $\mathrm{I}_{\text {COM(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{+}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, 3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=3 \mathrm{~V}, 0.3 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -2 | 1 | 2 | nA |
|  |  |  |  | Full | -18 |  | 18 |  |
| COM <br> ON leakage current ${ }^{(6)}$ | $\mathrm{I}_{\text {COM(ON })}$ | $\begin{aligned} & \mathrm{V}_{+}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, 3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=0.3 \mathrm{~V}, 3 \mathrm{~V} \text {, or floating } \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -2.5 | 0.01 | 2.5 | nA |
|  |  |  |  | Full | -5 |  | 5 |  |
| Dynamic |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{on}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \text {, See Figure } 14 \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 5 | 14 | ns |
|  |  |  |  | Full |  |  | 15 |  |
| Turn-off time | $\mathrm{t}_{\text {OFF }}$ | $\mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega,$$C_{L}=35 \mathrm{pF} \text {, See Figure } 14$ |  | $25^{\circ} \mathrm{C}$ |  | 4 | 9 | ns |
|  |  |  |  | Full |  |  | 10 |  |
| Charge injection | $\mathrm{Q}_{\mathrm{C}}$ | $\mathrm{V}_{\mathrm{GEN}}=0, \mathrm{R}_{\mathrm{GEN}}=0,$ <br> See Figure 15 | $=1 \mathrm{nF} \text {, }$ | $25^{\circ} \mathrm{C}$ |  | 3 |  | pC |
| NO OFF capacitance | $\mathrm{C}_{\text {NO(OFF) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure |  | $25^{\circ} \mathrm{C}$ |  | 23 |  | pF |
| COM OFF capacitance | $\mathrm{C}_{\text {COM(OFF) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure |  | $25^{\circ} \mathrm{C}$ |  | 20 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure |  | $25^{\circ} \mathrm{C}$ |  | 43 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, Switch ON |  | $25^{\circ} \mathrm{C}$ |  | 125 |  | MHz |
| OFF isolation ${ }^{(7)}$ | $\mathrm{O}_{\text {ISO }}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF},$ See Figure 17 | $\mathrm{f}=10 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -40 |  | dB |
|  |  |  | $\mathrm{f}=1 \mathrm{MHz}$ |  |  | -62 |  |  |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF},$ See Figure 17 | $\mathrm{f}=10 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -73 |  | dB |
|  |  |  | $\mathrm{f}=1 \mathrm{MHz}$ |  |  | -95 |  |  |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \\ & \mathrm{~V}_{\text {Com }}=2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=32 \Omega$ | $25^{\circ} \mathrm{C}$ |  | 0.04 |  | \% |
|  |  |  | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ |  |  | 0.003 |  |  |
| Digital Control Inputs (IN1-IN4) |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full | 1.4 |  |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  |  | 0.5 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{N}}$ | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{+}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.5 | 1 | nA |
|  |  |  |  | Full | -20 |  | 20 |  |
| Supply |  |  |  |  |  |  |  |  |
| Power-supply range | $\mathrm{V}_{+}$ |  |  |  | 1.6 |  | 3.6 | V |
| Positive-supply current | $I_{+}$ | $\mathrm{V}_{+}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0$ or $\mathrm{V}_{+}$ |  | $25^{\circ} \mathrm{C}$ |  |  | 0.075 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  | 0.75 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
(2) Parts are tested at $85^{\circ} \mathrm{C}$ and specified by design and correlation over the full temperature range.
(3) Typical values are at $\mathrm{V}_{+}=3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(4) $\Delta r_{\text {on }}=r_{\text {on (max })}-r_{\text {on(min) }}$
(5) Flatness is defined as the difference between the maximum and minimum value of $r_{\text {on }}$ as measured over the specified analog signal ranges.
(6) Leakage parameters are $100 \%$ tested at the maximum-rated hot operating temperature and specified by correlation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(7) OFF isolation $=20_{\log } 10\left(\mathrm{~V}_{\mathrm{COM}} / \mathrm{V}_{\mathrm{NO}}\right), \mathrm{V}_{\mathrm{COM}}=$ output, $\mathrm{V}_{\mathrm{NO}}=$ input to OFF switch

## Electrical Characteristics for 1.8-V Supply ${ }^{(1)(2)}$

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IH}}=1 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\mathrm{A}}$ | MIN | TYP ${ }^{(3)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {NO }}$ |  |  |  | 0 |  | $\mathrm{V}_{+}$ | V |
| ON-state resistance | $\mathrm{r}_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=-10 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{NO}}=0.9 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 1 | 1.5 | $\Omega$ |
|  |  |  |  | Full |  |  | 2 |  |
| ON-state resistance match between channels ${ }^{(4)}$ | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=-10 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{NO}}=0.9 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.09 | 0.15 | $\Omega$ |
|  |  |  |  | Full |  |  | 0.25 |  |
| ON-state resistance flatness ${ }^{(5)}$ | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=-10 \mathrm{~mA}, \\ & 0 \leq \mathrm{V}_{\mathrm{NO}} \leq \mathrm{V}_{+} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.7 | 0.9 | $\Omega$ |
|  |  |  |  | Full |  |  | 1.5 |  |
| NO <br> OFF leakage current ${ }^{(6)}$ | $\mathrm{I}_{\text {NO(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.95 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.15 \mathrm{~V}, 1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=1.8 \mathrm{~V}, 0.15 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -1 | 0.5 | 1 | nA |
|  |  |  |  | Full | -10 |  | 10 |  |
| COM <br> OFF leakage current ${ }^{(6)}$ | $\mathrm{I}_{\text {Com(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.95 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.15 \mathrm{~V}, 1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=1.65 \mathrm{~V}, 0.15 \mathrm{~V} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -1 | 0.5 | 1 | nA |
|  |  |  |  | Full | -10 |  | 10 |  |
| COM <br> ON leakage current ${ }^{(6)}$ | $\mathrm{I}_{\text {COM(ON }}$ | $\begin{aligned} & \mathrm{V}_{+}=1.95 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.15 \mathrm{~V}, 1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=0.15 \mathrm{~V}, 1.65 \mathrm{~V} \text {, or floating } \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | -1 | 0.01 | 1 | nA |
|  |  |  |  | Full | -3 |  | 3 |  |
| Dynamic |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{on}}$ | $\mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$, See Figure 14 |  | $25^{\circ} \mathrm{C}$ |  | 6 | 18 | ns |
|  |  |  |  | Full |  |  | 20 |  |
| Turn-off time | $\mathrm{t}_{\text {OFF }}$ | $\mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$, See Figure 14 |  | $25^{\circ} \mathrm{C}$ |  | 5 | 10 | ns |
|  |  |  |  | Full |  |  | 12 |  |
| Charge injection | $Q_{C}$ | $\mathrm{V}_{\mathrm{GEN}}=0, \mathrm{R}_{\mathrm{GEN}}=0, \mathrm{C}_{\mathrm{L}}=1$ <br> See Figure 15 |  | $25^{\circ} \mathrm{C}$ |  | 3.2 |  | pC |
| NO OFF capacitance | $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure 16 |  | $25^{\circ} \mathrm{C}$ |  | 23 |  | pF |
| COM OFF capacitance | $\mathrm{C}_{\text {COM (OFF) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure 16 |  | $25^{\circ} \mathrm{C}$ |  | 20 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{f}=1 \mathrm{MHz}$, See Figure 16 |  | $25^{\circ} \mathrm{C}$ |  | 43 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, Switch ON |  | $25^{\circ} \mathrm{C}$ |  | 123 |  | MHz |
| OFF isolation ${ }^{(7)}$ | $\mathrm{O}_{\text {ISO }}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$, See Figure 17 | $\mathrm{f}=10 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -61 |  | dB |
|  |  |  | $\mathrm{f}=100 \mathrm{MHz}$ |  |  | -36 |  |  |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF},$ <br> See Figure 17 | $\mathrm{f}=10 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -95 |  | dB |
|  |  |  | $\mathrm{f}=100 \mathrm{MHz}$ |  |  | -73 |  |  |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \mathrm{~V}_{\mathrm{COM}} \\ & =2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=32 \Omega$ | $25^{\circ} \mathrm{C}$ |  | 0.14 |  | \% |
|  |  |  | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ |  |  | 0.013 |  |  |
| Digital Control Inputs (IN1-IN4) |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full | 1 |  |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  |  | 0.4 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{N}}$ | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{+}$ |  | $25^{\circ} \mathrm{C}$ |  | 0.1 | 5 | nA |
|  |  |  |  | Full | -10 |  | 10 |  |
| Supply |  |  |  |  |  |  |  |  |
| Power-supply range | $\mathrm{V}_{+}$ |  |  |  | 1.6 |  | 3.6 | V |
| Positive-supply current | $I_{+}$ | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{+}$ |  | $25^{\circ} \mathrm{C}$ |  |  | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  | 0.5 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
(2) Parts are tested at $85^{\circ} \mathrm{C}$ and specified by design and correlation over the full temperature range.
(3) Typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(4) $\Delta r_{\text {on }}=r_{\text {on(max })}-r_{\text {on(min) }}$
(5) Flatness is defined as the difference between the maximum and minimum value of $r_{\text {on }}$ as measured over the specified analog signal ranges.
(6) Leakage parameters are $100 \%$ tested at the maximum-rated hot operating temperature and specified by correlation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(7) OFF isolation $=20_{\log } 10\left(\mathrm{~V}_{\mathrm{COM}} / \mathrm{V}_{\mathrm{NO}}\right), \mathrm{V}_{\mathrm{COM}}=$ output, $\mathrm{V}_{\mathrm{NO}}=$ input to OFF switch

## TYPICAL PERFORMANCE



Figure 1. $\mathrm{r}_{\mathrm{on}} \mathrm{vs} \mathrm{V}_{\mathrm{Com}}$


Figure 3. $\mathrm{r}_{\mathrm{on}}$ vs $\mathrm{V}_{\text {com }}\left(\mathrm{V}_{+}=2.7 \mathrm{~V}\right)$


Figure 5. $\mathrm{Q}_{\mathrm{C}}$ vs $\mathrm{V}_{\text {com }}$


Figure 2. $\mathrm{r}_{\text {on }}$ vs $\mathrm{V}_{\text {com }}\left(\mathrm{V}_{+}=1.8 \mathrm{~V}\right)$


Figure 4. $\mathrm{I}_{\mathrm{ON}}$ and $\mathrm{I}_{\mathrm{OFF}}$ vs Temperature ( $\mathrm{V}_{+}=3.6 \mathrm{~V}$ )


Figure 6. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}}$ vs Supply Voltage
0.9- $\Omega$ LOW-VOLTAGE SINGLE-SUPPLY QUAD SPST ANALOG SWITCH

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TYPICAL PERFORMANCE (continued)


Figure 7. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}}$ vs Temperature


Figure 9. Gain vs Frequency
( $\mathrm{V}_{+}=3 \mathrm{~V}$ )


Figure 11. Total Harmonic Distortion vs Frequency ( $\mathrm{R}_{\mathrm{L}}=32 \Omega$ )


Figure 8. $\mathrm{I}_{\mathrm{Cc}}$ vs $\mathrm{V}_{+}$


Figure 10. OFF Isolation vs Frequency
( $\mathrm{V}_{+}=3 \mathrm{~V}$ )


Figure 12. Total Harmonic Distortion vs Frequency ( $\mathrm{R}_{\mathrm{L}}=600 \Omega$ )

TYPICAL PERFORMANCE (continued)


Figure 13. Crosstalk vs Frequency ( $\mathrm{V}_{+}=3 \mathrm{~V}$ )

## PIN DESCRIPTION

| PIN NO. | NAME | DESCRIPTION |
| :---: | :---: | :--- |
| $1,3,8,11$ | NO1, NO2, NO3, NO4 | Normally open |
| $2,4,9,10$ | COM1, COM2, COM3, | Common |
| 7 | COM4 | Ground |
| $13,5,6,12$ | GND | Logic control inputs |
| 14 | $\mathrm{~V}_{+}$ | Positive supply voltage |

## APPLICATION INFORMATION

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings can cause permanent damage to the devices. Always sequence $\mathrm{V}_{+}$on first, followed by NO or COM.
Although it is not required, power-supply bypassing improves noise margin and prevents switching noise propagation from the $V_{+}$supply to other components. A $0.1-\mu \mathrm{F}$ capacitor, connected from $\mathrm{V}_{+}$to $G N D$, is adequate for most applications.

## Logic Inputs

The TS3A4751 logic inputs can be driven up to 3.6 V , regardless of the supply voltage. For example, with a $1.8-\mathrm{V}$ supply, IN may be driven low to GND and high to 3.6 V . Driving IN rail to rail minimizes power consumption.

## Analog Signal Levels

Analog signals that range over the entire supply voltage ( $\mathrm{V}_{+}$to GND) can be passed with very little change in $\mathrm{r}_{\mathrm{on}}$ (see Typical Operating Characteristics). The switches are bidirectional, so NO and COM can be used as either inputs or outputs.

## Layout

High-speed switches require proper layout and design procedures for optimum performance. Reduce stray inductance and capacitance by keeping traces short and wide. Ensure that bypass capacitors are as close to the device as possible. Use large ground planes where possible.

## TEST CIRCUITS/TIMING DIAGRAMS



Figure 14. Switching Times


Figure 15. Charge Injection $\left(Q_{C}\right)$

TEST CIRCUITS/TIMING DIAGRAMS (continued)


Figure 16. NO and COM Capacitance


Figure 17. OFF Isolation, Bandwidth, and Crosstalk

## TEST CIRCUITS/TIMING DIAGRAMS (continued)


A. $\quad C_{L}$ includes probe and jig capacitance.

Figure 18. Total Harmonic Distortion (THD)

## PACKAGING INFORMATION

| Orderable Device | Status $^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3A4751PWR | ACTIVE | TSSOP | PW | 14 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TS3A4751PWRG4 | ACTIVE | TSSOP | PW | 14 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The $\mathrm{Pb}-\mathrm{Free} / \mathrm{Green}$ conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb -Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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| PIM PINS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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